

## 产品规格书

## SPECIFICATIONS FOR PRODUCT

产品类型 TYPE: Crystal Oscillator

产品规格 SPEC : 12.288MHz/7050/3.3V

产品型号 P/N : CJ003-122883320B30

**日期** DATE: 2019/07/03

核准及签名			部パコ
R&D APPR. SIGNATURED			DEPT.
拟制 审核		批准	频率器件事业部
ISSUE	CHECK	APPROVAL	
王嘉诚	许秋菊 2019/07/03	杨立新	

### 江 苏 长 晶 科 技 有 限 公 司 JIANGSU CHANGJING ELECTRONICS TECHNOLOGY CO., LTD

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# SMD7.0 \* 5.0 Crystal Oscillator

### CJO03-122883320B30

1	Sco	D	e	:

1.1 This specification applies to the RoHS crystal oscillator with a frequency of 12.288MHz which will be used in electronic equipment.

2. Construction:

2.1 Oscillators series: SMD 7×5 XO

2.2 Package: SMD 7×5

3. Electrical Characteristics

3.1 Nominal Frequency: 12.288MHz
 3.2 Frequency Stability: ±20 ppm

(incl. 25°C tolerance, )

3.3 Aging: ±3ppm/year

3.4 Operating Temperature Range:  $-40 \,^{\circ}\text{C}$  to  $+85 \,^{\circ}\text{C}$ 

3.5 Storage Temperature Range:  $-55^{\circ}$ C to  $+125^{\circ}$ C

3.6 Input Voltage ( $V_{DD}$ ): +3.3Vdc±10%

3.7 Input Current (I<sub>DD</sub>): 10mA max

3.8 Output Waveform: CMOS

3.9 Output Symmetry: 50±10%

3.10 Rise/Fall Time: 10ns max

3.11 Output Voltage V<sub>OL</sub>: 10%VDD

 $V_{OH}$ : 90%VDD

3.12 Output Load: 15pF

3.13 Output State Control: Enable/disable

3.14 Start-up Time: 5ms max
3.15 Standby current: 10μA max
3.16 Period Jitter: 40ps max

3.17 Oscillation mode: A1

3.18 Others: Not recommended for safety applications

## 4. Reliability Specifications

This is the quality control and quality assurance and relaibility tests performance data for the RoHS 12.288MHz SMD 7×5 XO

related to the specification and approval sheet provided by JSCJ .

Standard test condition (TEMP.: 20±15°C. Relative humidity: 65±20%)

For any discripancy in GO/NG, test will be done at TEMP.25±2℃. R.H. 65±5%.

NO.	ITEM	SPECIFICATION	TEST METHOD
4.1	Temperature Cycle (GB/T 2423.22-2002, Method Nb)	Frequency change after test≤± 5ppm.	10 cycles from -55°C to 125°C. Measurement taken after DUT being left at room temperature for 24±2 hours.
4.2	Low Temperature Storage (GB/T 2423.1-2001, Method Aa)	Frequency change after test≤± 5ppm.	Spending 72 hrs at -55°C±3°C constant temperature.  Measurement taken after DUT being left at room temperature for 24±2 hours.
4.3	High Temperature Storage (GB/T 2423.2-2001, Method Ba)	Frequency change after test≤± 5ppm.	Spending 72 hrs at 125°C±3°C constant temperature.  Measurement taken after DUT being left at room temperature for 24±2 hours.
4.4	Humidity (GB/T 2423.3- 2006, Method Cab)	Frequency change after test≤± 5ppm.	Spending 96 hrs at 40 °C ± 3 °C, with 90± 3% R.H. Measurement taken after DUT being left at room temperature for 24±2 hours.
4.5	Vibration (GB/T 2423.10- 1995, Method Fc)	Frequency change after test≤± 5ppm.	Apply 0.75mm vibration at sweep frequency 10 $\sim$ 500 Hz, for 2h. 10 cycles in each direction of 3 axis. Measurement taken after 1 hour.
4.6	Shock (GB/T 2423.5-1995, Method Ea)	Frequency change after test≤± 5ppm. No visible damages.	Peak 1000m/s2, normal width 6ms half sine wave form, 3.7m/s, 3 perpendicular axis of samples, 3 cycles / direction, total 18 cycles. Measurement taken after 1 hour.
4.7	Drop (GB/T 2423.8-1995, Method Ed)	Frequency change after test≤± 5ppm. No visible damages.	Free drop to the wooden plate from 1.0 m heights for 3 times.
4.8	Solderability (GB/T 2423.28-2005, Method Tc)	Terminals shall be covered more then 95% with solder.	In 255 $\pm$ 5°C solder bath for 2 $\pm$ 0.5 seconds. There is no need to do functioned test. 8-12X magnifier.
4.9	Terminal Strength (JIS-C-6429 Method 1 & 2 )	No visible damage	Mount on a glass-epoxy board (100x50x1.6mm), then bend to 2mm displacement (velocity 1mm/sec) and keep for 5 seconds. or pulling force 0.5 kg for at least 60 seconds.
4.10	Resistance to Soldering Heat (GB/T 2423.28-2005, Test Tb Method 1B)	Frequency change after test≤± 5ppm.	Passed through the re-flow oven under the following condition. Preheat to 150°C±5°C for 60 to 120sec,and peak 265°C±5°C for 10s±3sec.Measurement taken after DUT being left at room temperature for at 24±2 hours.
4.11	OTHERS		

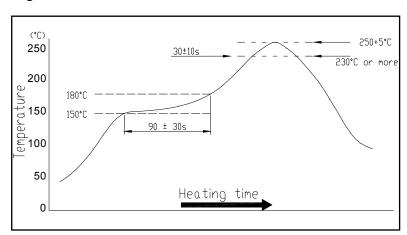
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### 5. Recommended Reflow soldering condition (SMD)

#### ■ Solder profile

Peak: 250<sup>+5</sup><sub>0</sub>°C Soldering zone: 230°C or more, 30±10s.

Pre-heating zone 1: 150~180°C, 90±30s



Temperature profile for reflow soldering

## 6. Soldering iron method

Bit temperature:  $350\pm10^{\circ}$ C Application time of soldering iron:3+1 s For other procedures, refer to IEC 60068-2-20.

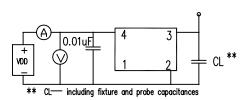
#### PIN CONNECTION

P/N	CJO03
1	Enable/Disable *
2	GND
3	Output
4	VDD

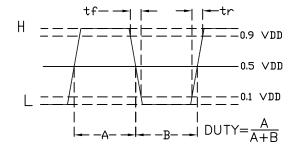
\* Enable/Disable functional description
When pin1 goes high (>=0.7VDD) or open ,the Oscillator in
normal operation and has output in frequency. When pin1
goes low (<=0.3VDD) ,the oscillator stops and the oscillator
output (Pin3) becomes high impedance.

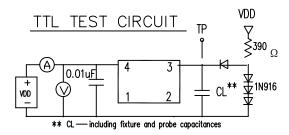
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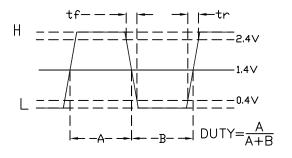


TYPICAL CMOS WAVE FORM

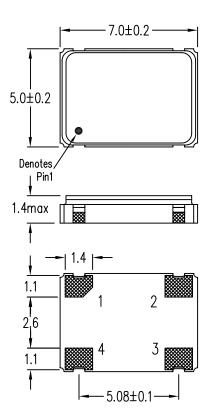




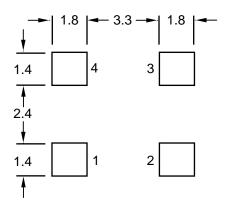
TYPICAL TTL WAVE FORM



### **Package Outline Dimensions**

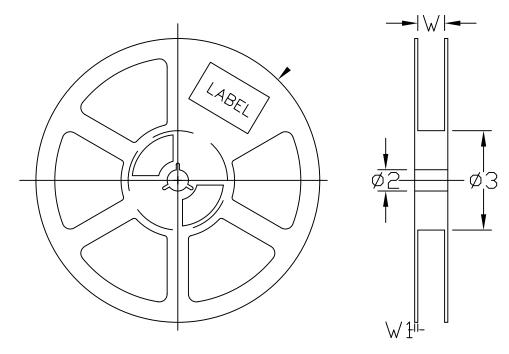


## **Suggested Pad Layout**



#### NOTICE

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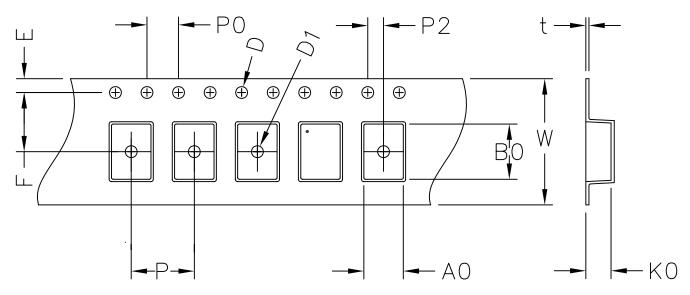


REEL DIMENSIONS

ITEM	Ø1±0.5	ø2±0.25	ø3±0.3	W±0.2	W1±0,25
16mm	178	13.2	62.5	16.4	2

JSCJ P/N: xxx...xxx Freq: ff.fff LABEL:

Qty: **1000**Pcs



EMBOSSED TYPE DIMENSIONS

ITEM	W+0.3/0.1	A0±0.1	B0±0.1	K0±0.1	P±0.1	F±0.1	t±0.05	Qty
149	16.0	5.5	7.5	2.0	8.0	7.5	0.3	1000

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E=1.75±0.1, D=1.5±0.1, D1=1.5+0.25/-0.0, P0=4.0±0.1, P2=2.0±0.1

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